**3U VPX SSD Carriers** 

XPort6173



# End of Life

3U VPX Carrier for Two 2.5 in. Solid-State Drives (SSDs)

Please see XPort6175

## XPort6173

The XPort6173 supports two, standard, 2.5 in. Solid-State Drives (SSDs) in a single 0.8 in. or 1.0 in. 3U VPX slot. It provides system integrators quick and easy access to the latest high-density SSD options in a rugged, compact, COTS package. The XPort6173's design mitigates life cycle issues that plague other flash-based storage solutions.

The XPort6173 supports a x2 PCI Express 2.0 interface to the backplane for flexible system connectivity options. Standard configurations of up to 4 TB are available. These modules have been tested and utilize the latest high-density SLC- and MLC-based flash solutions.



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Supports up to two 2.5 in.
Solid-State Drives (SSDs)

> 3U VPX (VITA 46) module

- 0.8 in. or 1.0 in. VPX slot pitch
- ➤ Compatible with multiple VITA 65 OpenVPX<sup>™</sup> slot profiles
- x2 PCI Express Gen2 interface
- Up to 4 TB of storage in MLC-based flash configurations
- > Up to 1 TB in SLC-based flash configurations

#### VPX (VITA 46) I/O

• x2 PCI Express Gen2 to P1

#### **Storage Characteristics**

- Supports up to two ruggedized and shop-replaceable 2.5 in. Solid-State Drives (SSDs)
- Serial ATA (SATA) 6 Gb/s
- Can be used as a bootable drive

### **Predefined Configurations**

- 256 GB of MLC-based flash storage in one drive
- 512 GB of MLC-based flash storage in one drive
- 1 TB of MLC-based flash storage in one drive
- 2 TB of MLC-based flash storage in one drive
- 4 TB of MLC-based flash storage in two drives
- 512 GB of SLC-based flash storage in one drive
- 1 TB of SLC-based flash storage in one drive

#### **Physical Characteristics**

- 3U VPX conduction-cooled form factor
- 0.8 in. or 1.0 in. VPX slot pitch
- Dimensions: 100 mm x 160 mm

#### **Environmental Requirements**

Contact factory for appropriate board configuration based on environmental requirements.

- Supported ruggedization levels (see chart below): 5
- Conformal coating available as an ordering option

#### **Power Requirements**

• Power requirements vary depending on SSDs installed. Contact X-ES for additional information.

Ruggedization Level	Level 5
Cooling Method	Conduction-Cooled
Operating Temperature	-40 to +85°C (board rail surface)
Storage Temperature	-55 to +105°C (maximum)
Vibration	0.1 g²/Hz (maximum), 5 to 2000 Hz
Shock	40 g, 11 ms sawtooth
Humidity	Up to 95% non-condensing



